

# OptiMOS™ 2 + OptiMOS™-P 2 Small Signal Transistor

## Features

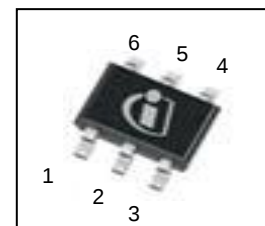
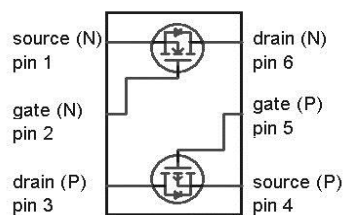
- Complementary P + N channel
- Enhancement mode
- Super Logic level (2.5V rated)
- Avalanche rated
- Qualified according to AEC Q101
- 100% lead-free; RoHS compliant
- Halogen-free according to IEC61249-2-21



## Product Summary

|                  |                           | P     | N    |           |
|------------------|---------------------------|-------|------|-----------|
| $V_{DS}$         |                           | -20   | 20   | V         |
| $R_{DS(on),max}$ | $V_{GS}=\pm 4.5\text{ V}$ | 1200  | 350  | $m\Omega$ |
|                  | $V_{GS}=\pm 2.5\text{ V}$ | 2100  | 600  |           |
| $I_D$            |                           | -0.53 | 0.95 | A         |

PG-SOT-363



| Type    | Package    | Tape and Reel Information | Marking | Lead Free | Packing |
|---------|------------|---------------------------|---------|-----------|---------|
| BSD235C | PG-SOT-363 | H6327: 3000 pcs / reel    | X9s     | Yes       | Non dry |

**Maximum ratings**, at  $T_j=25\text{ }^{\circ}\text{C}$ , unless otherwise specified <sup>1)</sup>

| Parameter                           | Symbol         | Conditions                                                                         | Value       |      | Unit               |
|-------------------------------------|----------------|------------------------------------------------------------------------------------|-------------|------|--------------------|
|                                     |                |                                                                                    | P           | N    |                    |
| Continuous drain current            | $I_D$          | $T_A=25\text{ }^{\circ}\text{C}$                                                   | -0.53       | 0.95 | A                  |
|                                     |                | $T_A=70\text{ }^{\circ}\text{C}$                                                   | -0.46       | 0.76 |                    |
| Pulsed drain current                | $I_{D,pulse}$  | $T_A=25\text{ }^{\circ}\text{C}$                                                   | -2.1        | 3.8  |                    |
| Avalanche energy, single pulse      | $E_{AS}$       | P: $I_D=-0.53\text{ A}$ ,<br>N: $I_D=0.95\text{ A}$ ,<br>$R_{GS}=25\text{ }\Omega$ | 1.4         | 1.6  | mJ                 |
| Gate source voltage                 | $V_{GS}$       |                                                                                    | $\pm 12$    |      | V                  |
| Power dissipation                   | $P_{tot}$      | $T_A=25\text{ }^{\circ}\text{C}$                                                   | 0.5         |      | W                  |
| Operating and storage temperature   | $T_j, T_{stg}$ |                                                                                    | -55 ... 150 |      | $^{\circ}\text{C}$ |
| ESD class                           |                | JESD22-A114-HBM                                                                    | 0 (<250V)   |      | $^{\circ}\text{C}$ |
| Soldering temperature               | $T_{solder}$   |                                                                                    | 260         |      | $^{\circ}\text{C}$ |
| IEC climatic category; DIN IEC 68-1 |                |                                                                                    | 55/150/56   |      |                    |

<sup>1)</sup> Remark: only one of both transistors active

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Thermal characteristics**

|                                        |   |            |                                 |   |   |     |     |
|----------------------------------------|---|------------|---------------------------------|---|---|-----|-----|
| Thermal resistance, junction - ambient | P | $R_{thJA}$ | minimal footprint <sup>2)</sup> | - | - | 250 | K/W |
|                                        | N |            |                                 |   |   |     |     |

**Electrical characteristics, at  $T_j=25\text{ °C}$ , unless otherwise specified**
**Static characteristics**

|                                  |   |               |                                                             |      |      |           |               |
|----------------------------------|---|---------------|-------------------------------------------------------------|------|------|-----------|---------------|
| Drain-source breakdown voltage   | P | $V_{(BR)DSS}$ | $V_{GS}=0\text{ V}, I_D=-250\text{ }\mu\text{A}$            | -    | -    | -20       | V             |
|                                  | N |               | $V_{GS}=0\text{ V}, I_D=250\text{ }\mu\text{A}$             | 20   | -    | -         |               |
| Gate threshold voltage           | P | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=-1.5\text{ }\mu\text{A}$                | -1.2 | -0.9 | -0.6      |               |
|                                  | N |               | $V_{DS}=V_{GS}, I_D=1.6\text{ }\mu\text{A}$                 | 0.7  | 0.95 | 1.2       |               |
| Zero gate voltage drain current  | P | $I_{DSS}$     | $V_{DS}=-20\text{ V}, V_{GS}=0\text{ V}, T_j=25\text{ °C}$  | -    | -    | -1        | $\mu\text{A}$ |
|                                  | N |               | $V_{DS}=20\text{ V}, V_{GS}=0\text{ V}, T_j=25\text{ °C}$   | -    | -    | 1         |               |
|                                  | P |               | $V_{DS}=-20\text{ V}, V_{GS}=0\text{ V}, T_j=150\text{ °C}$ | -    | -    | -100      |               |
|                                  | N |               | $V_{DS}=20\text{ V}, V_{GS}=0\text{ V}, T_j=150\text{ °C}$  | -    | -    | 100       |               |
| Gate-source leakage current      | P | $I_{GSS}$     | $V_{GS}=\pm 12\text{ V}, V_{DS}=0\text{ V}$                 | -    | -    | $\pm 100$ | nA            |
|                                  | N |               |                                                             |      |      |           |               |
| Drain-source on-state resistance | P | $R_{DS(on)}$  | $V_{GS}=-2.5\text{ V}, I_D=-0.17\text{ A}$                  | -    | 1221 | 2100      | m $\Omega$    |
|                                  | N |               | $V_{GS}=2.5\text{ V}, I_D=0.29\text{ A}$                    | -    | 415  | 600       |               |
|                                  | P |               | $V_{GS}=-4.5\text{ V}, I_D=-0.53\text{ A}$                  | -    | 745  | 1200      |               |
|                                  | N |               | $V_{GS}=4.5\text{ V}, I_D=0.95\text{ A}$                    | -    | 266  | 350       |               |
| Transconductance                 | P | $g_{fs}$      | $ V_{DS} >2 I_D R_{DS(on)max}, I_D=-0.46\text{ A}$          | -    | 0.7  | -         | S             |
|                                  | N |               | $ V_{DS} >2 I_D R_{DS(on)max}, I_D=0.76\text{ A}$           | -    | 2    | -         |               |

<sup>2)</sup> Performed on 40mm<sup>2</sup> FR4 PCB. The traces are 1mm wide, 70 $\mu\text{m}$  thick and 20mm long; they are present on both sides of the PCB

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Dynamic characteristics**

|                              |   |              |                                                                                                                                                                                                       |   |     |   |    |
|------------------------------|---|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|-----|---|----|
| Input capacitance            | P | $C_{iss}$    | $V_{GS}=0\text{ V}$ ,<br>P: $V_{DS}=-10\text{ V}$ ,<br>N: $V_{DS}=10\text{ V}$ ,<br>$f=1\text{ MHz}$                                                                                                  | - | 37  | - | pF |
|                              | N |              |                                                                                                                                                                                                       | - | 47  | - |    |
| Output capacitance           | P | $C_{oss}$    |                                                                                                                                                                                                       | - | 17  | - |    |
|                              | N |              |                                                                                                                                                                                                       | - | 24  | - |    |
| Reverse transfer capacitance | P | $C_{rss}$    |                                                                                                                                                                                                       | - | 14  | - |    |
|                              | N |              |                                                                                                                                                                                                       | - | 3   | - |    |
| Turn-on delay time           | P | $t_{d(on)}$  | P: $V_{DD}=-10\text{ V}$ ,<br>$V_{GS}=-4.5\text{ V}$ , $R_G=6\ \Omega$ ,<br>$I_D=-0.53\text{ A}$<br><br>N: $V_{DD}=10\text{ V}$ ,<br>$V_{GS}=4.5\text{ V}$ , $R_G=6\ \Omega$ ,<br>$I_D=0.95\text{ A}$ | - | 3.8 | - | ns |
|                              | N |              |                                                                                                                                                                                                       | - | 3.8 | - |    |
| Rise time                    | P | $t_r$        |                                                                                                                                                                                                       | - | 5.0 | - |    |
|                              | N |              |                                                                                                                                                                                                       | - | 3.6 | - |    |
| Turn-off delay time          | P | $t_{d(off)}$ |                                                                                                                                                                                                       | - | 5.1 | - |    |
|                              | N |              |                                                                                                                                                                                                       | - | 4.5 | - |    |
| Fall time                    | P | $t_f$        |                                                                                                                                                                                                       | - | 3.2 | - |    |
|                              | N |              |                                                                                                                                                                                                       | - | 1.2 | - |    |

**Gate Charge Characteristics**

|                       |   |               |                                                                                         |   |       |   |    |
|-----------------------|---|---------------|-----------------------------------------------------------------------------------------|---|-------|---|----|
| Gate to source charge | P | $Q_{gs}$      | $V_{DD}=-10\text{ V}$ ,<br>$I_D=-0.53\text{ A}$ ,<br>$V_{GS}=0\text{ to }-4.5\text{ V}$ | - | -0.09 | - | nC |
| Gate to drain charge  |   | $Q_{gd}$      |                                                                                         | - | -0.2  | - |    |
| Switching charge      |   | $Q_g$         |                                                                                         | - | -0.4  | - |    |
| Gate plateau voltage  |   | $V_{plateau}$ |                                                                                         | - | -2.4  | - |    |
| Gate to source charge | N | $Q_{gs}$      | $V_{DD}=16\text{ V}$ ,<br>$I_D=0.95\text{ A}$ ,<br>$V_{GS}=0\text{ to }4.5\text{ V}$    | - | 0.11  | - |    |
| Gate to drain charge  |   | $Q_{gd}$      |                                                                                         | - | 0.09  | - |    |
| Switching charge      |   | $Q_g$         |                                                                                         | - | 0.34  | - |    |
| Gate plateau voltage  |   | $V_{plateau}$ |                                                                                         | - | 2.4   | - |    |

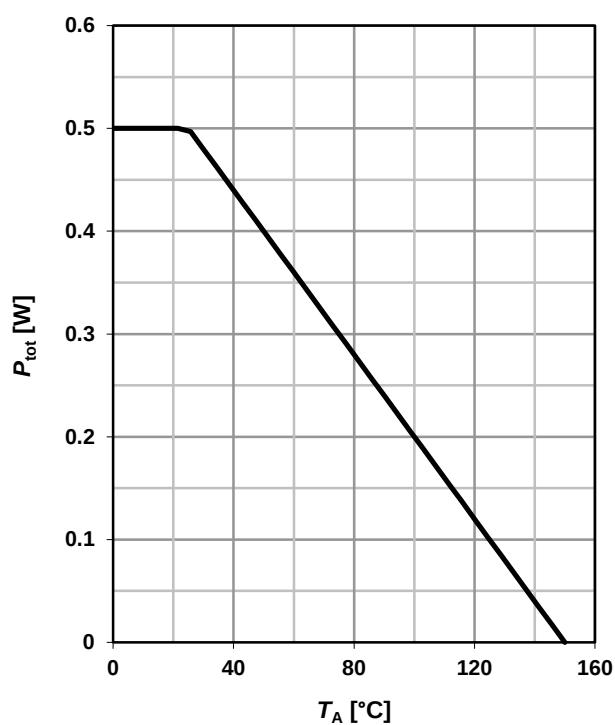
| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Reverse Diode**

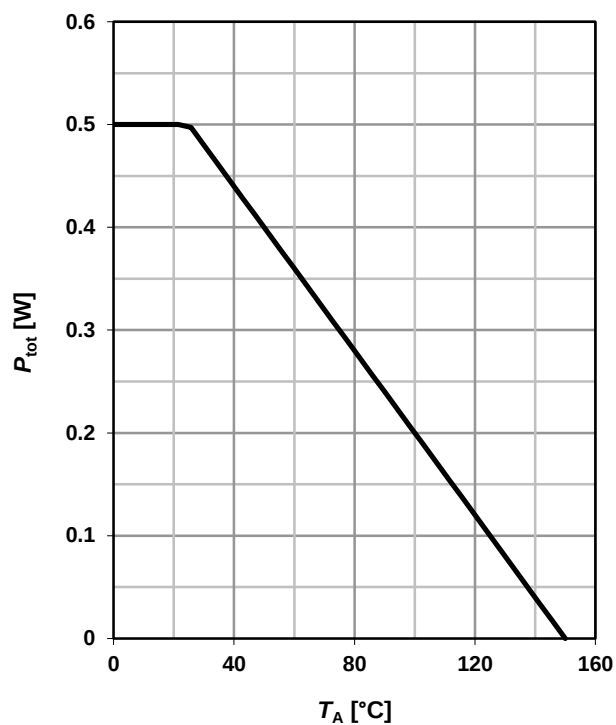
|                                  |   |               |                                                                       |   |      |       |    |
|----------------------------------|---|---------------|-----------------------------------------------------------------------|---|------|-------|----|
| Diode continuous forward current | P | $I_S$         | $T_C=25\text{ °C}$                                                    | - | -    | -0.42 | A  |
|                                  | N |               |                                                                       |   |      | 0.5   |    |
| Diode pulse current              | P | $I_{S,pulse}$ |                                                                       | - | -    | -2.1  |    |
|                                  | N |               |                                                                       | - | -    | 3.8   |    |
| Diode forward voltage            | P | $V_{SD}$      | $V_{GS}=0\text{ V}, I_F=-0.53\text{ A},$<br>$T_j=25\text{ °C}$        | - | -1   | -1.2  | V  |
|                                  | N |               | $V_{GS}=0\text{ V}, I_F=0.95\text{ A},$<br>$T_j=25\text{ °C}$         | - | 0.9  | 1.1   |    |
| Reverse recovery time            | P | $t_{rr}$      | $V_R=\pm 10\text{ V}, I_F=I_S,$<br>$di_F/dt=100\text{ A}/\mu\text{s}$ | - | 7.6  | -     | ns |
|                                  | N |               |                                                                       | - | 5.2  | -     |    |
| Reverse recovery charge          | P | $Q_{rr}$      |                                                                       | - | 1.1  | -     | nC |
|                                  | N |               |                                                                       | - | 0.97 | -     |    |

**1 Power dissipation (P)**

$$P_{\text{tot}} = f(T_A)$$

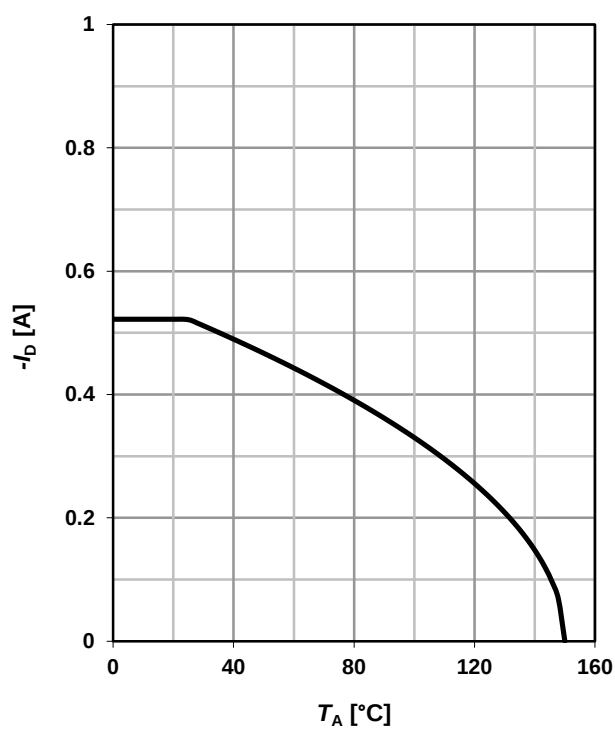

**2 Power dissipation (N)**

$$P_{\text{tot}} = f(T_A)$$


**3 Drain current (P)**

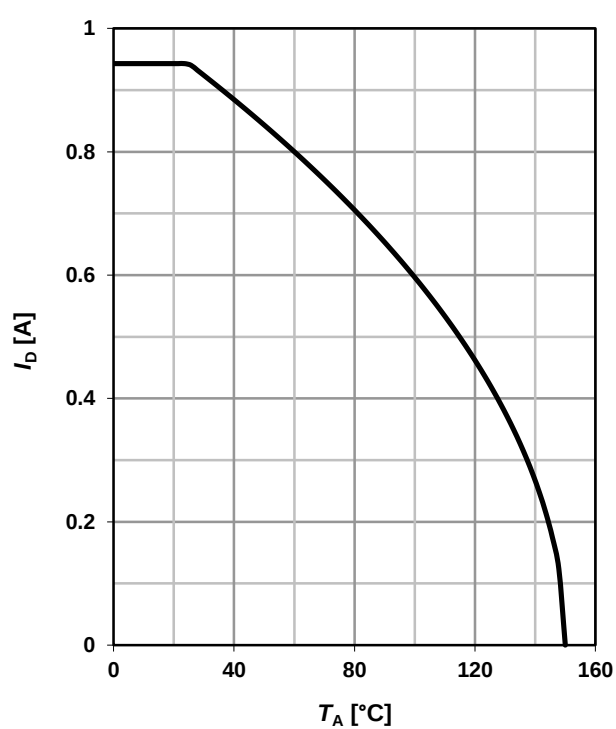
$$I_D = f(T_A)$$

parameter:  $V_{GS} \leq 4.5$  V


**4 Drain current (N)**

$$I_D = f(T_A)$$

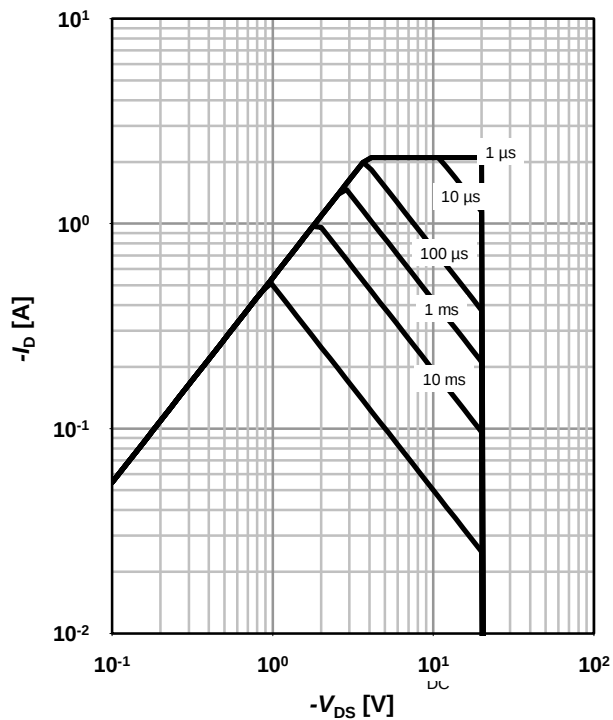
parameter:  $V_{GS} \geq 4.5$  V



### 5 Safe operating area (P)

$I_D = f(V_{DS}); T_A = 25^\circ\text{C}; D = 0$

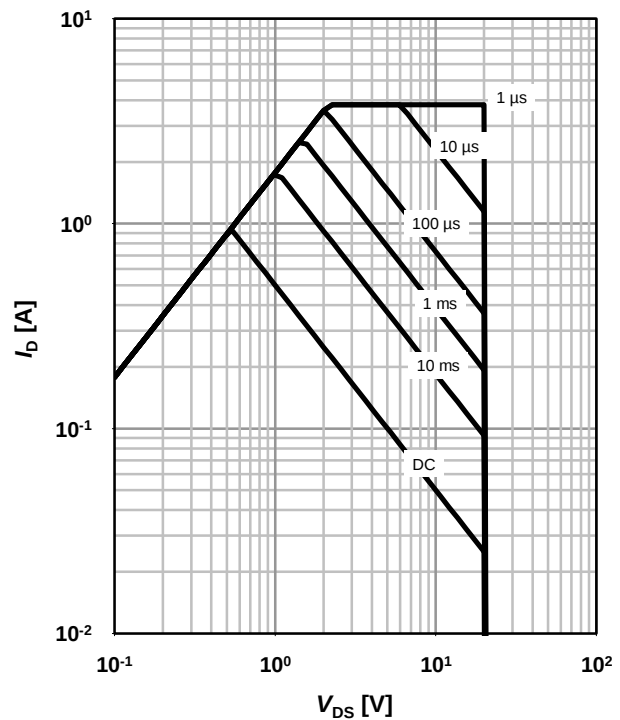
parameter:  $t_p$



### 6 Safe operating area (N)

$I_D = f(V_{DS}); T_A = 25^\circ\text{C}; D = 0$

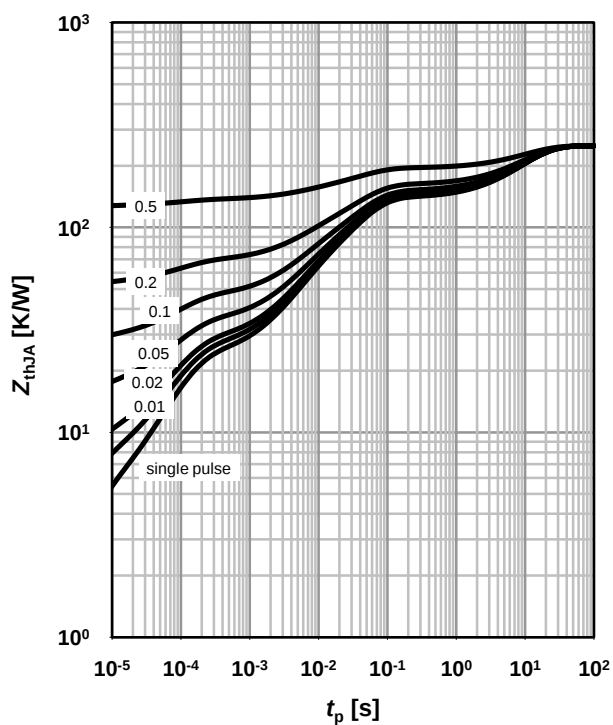
parameter:  $t_p$



### 7 Max. transient thermal impedance (P)

$Z_{thJA} = f(t_p)$

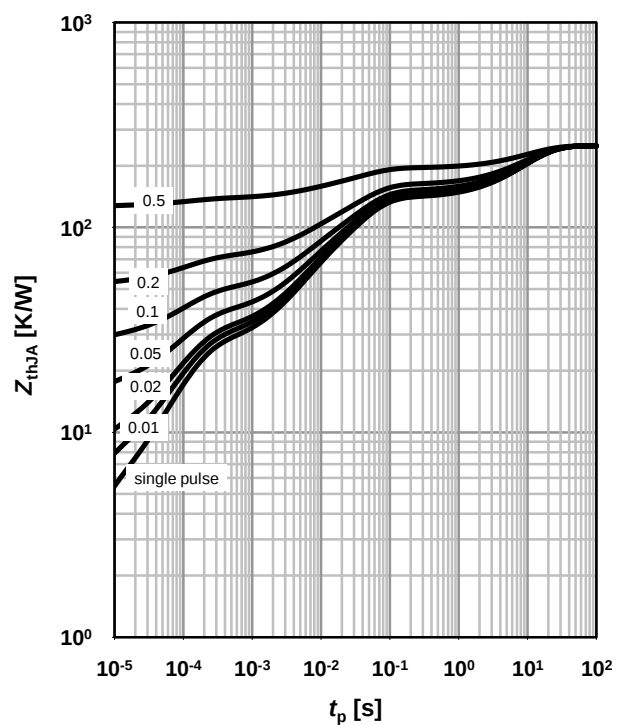
parameter:  $D = t_p/T$



### 8 Max. transient thermal impedance (N)

$Z_{thJA} = f(t_p)$

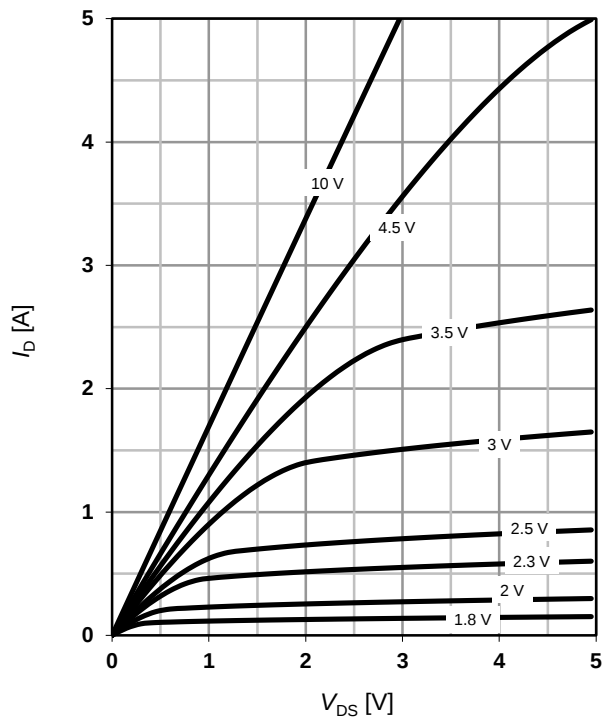
parameter:  $D = t_p/T$



**9 Typ. output characteristics (P)**

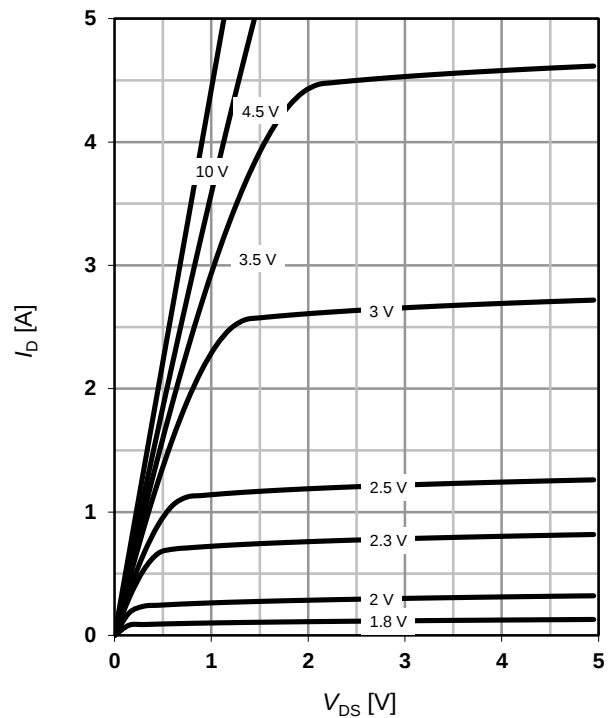
$$I_D = f(V_{DS}); T_j = 25^\circ\text{C}$$

parameter:  $V_{GS}$


**10 Typ. output characteristics (N)**

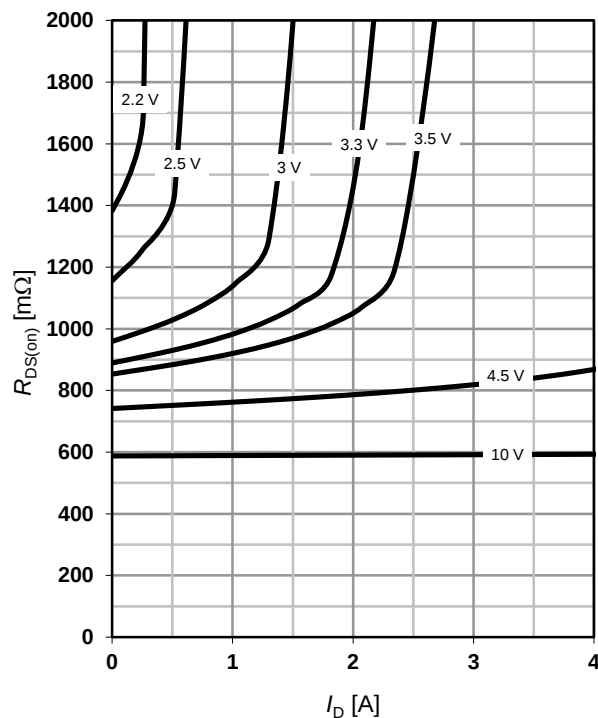
$$I_D = f(V_{DS}); T_j = 25^\circ\text{C}$$

parameter:  $V_{GS}$


**11 Typ. drain-source on resistance (P)**

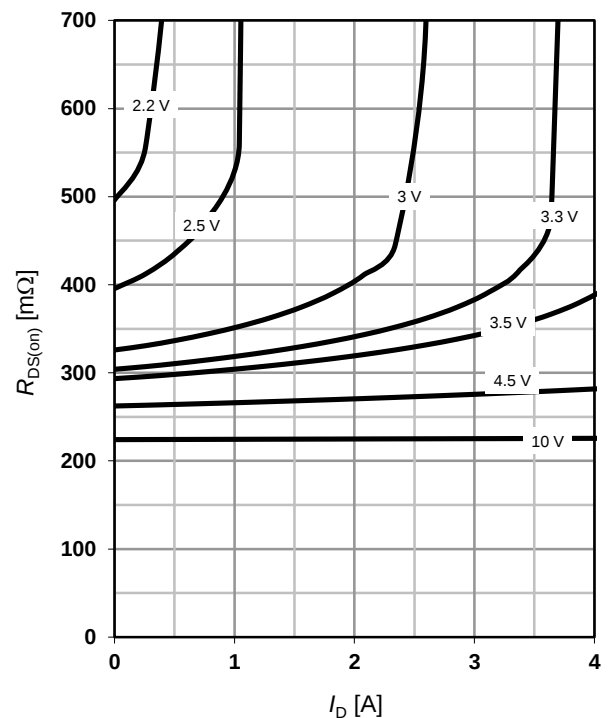
$$R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$$

parameter:  $V_{GS}$


**12 Typ. drain-source on resistance (N)**

$$R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$$

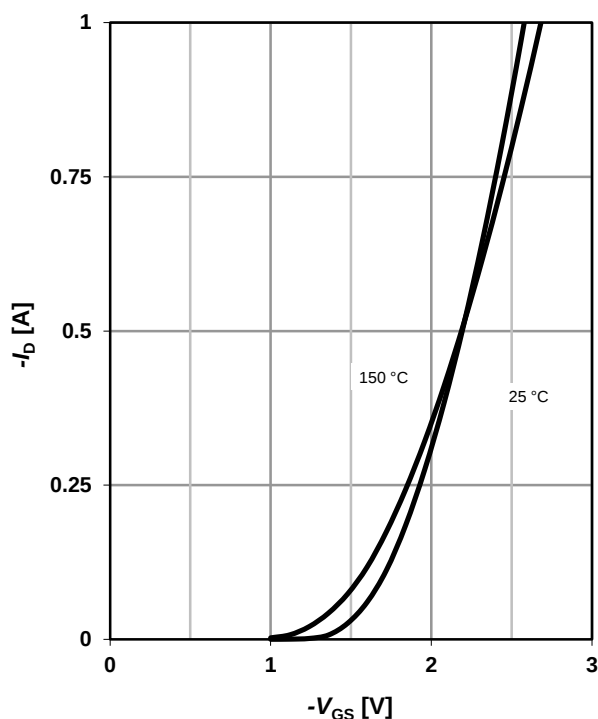
parameter:  $V_{GS}$



### 13 Typ. transfer characteristics (P)

$I_D = f(V_{GS}); |V_{DS}| > 2 |I_D| R_{DS(on)max}$

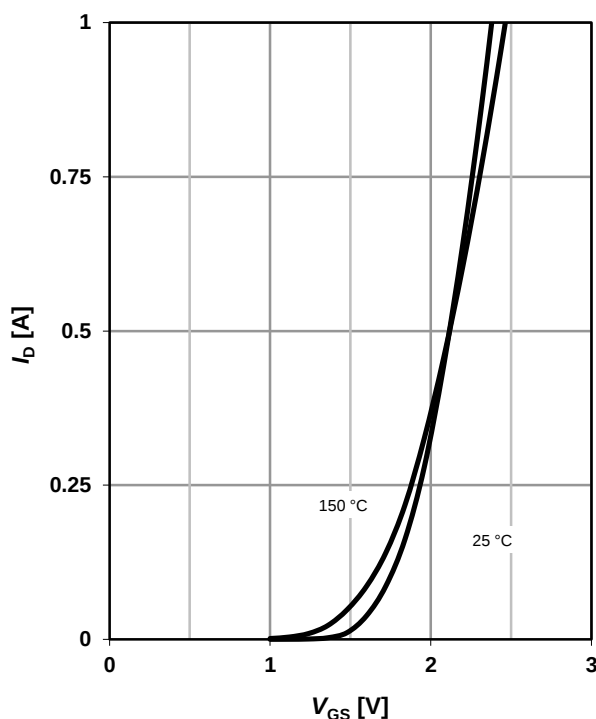
parameter:  $T_j$



### 14 Typ. transfer characteristics (N)

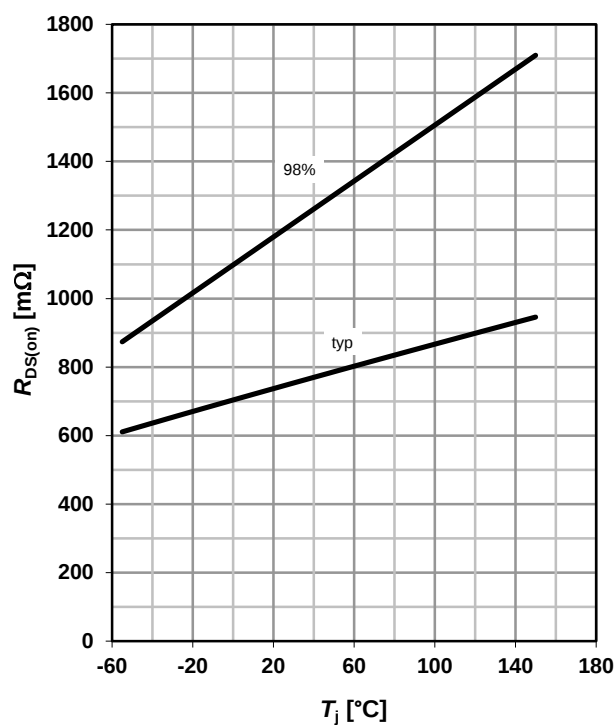
$I_D = f(V_{GS}); |V_{DS}| > 2 |I_D| R_{DS(on)max}$

parameter:  $T_j$



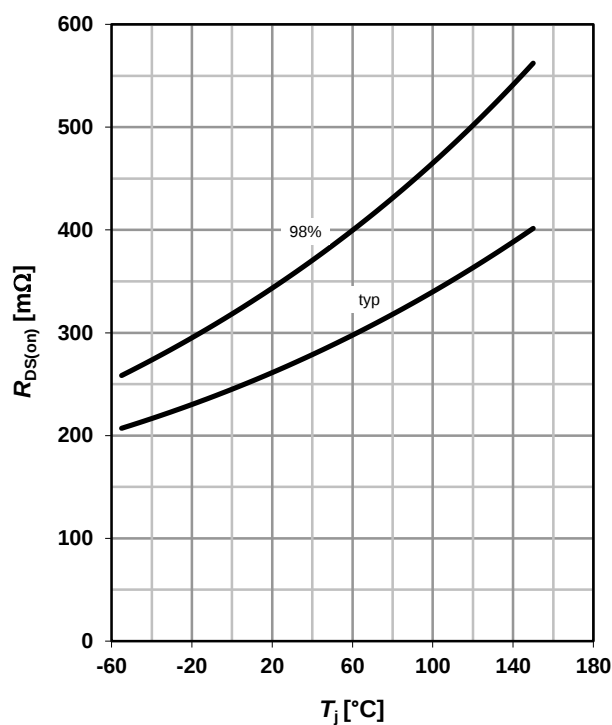
### 15 Drain-source on-state resistance (P)

$R_{DS(on)} = f(T_j); I_D = -0.53 \text{ A}; V_{GS} = -4.5 \text{ V}$



### 16 Drain-source on-state resistance (N)

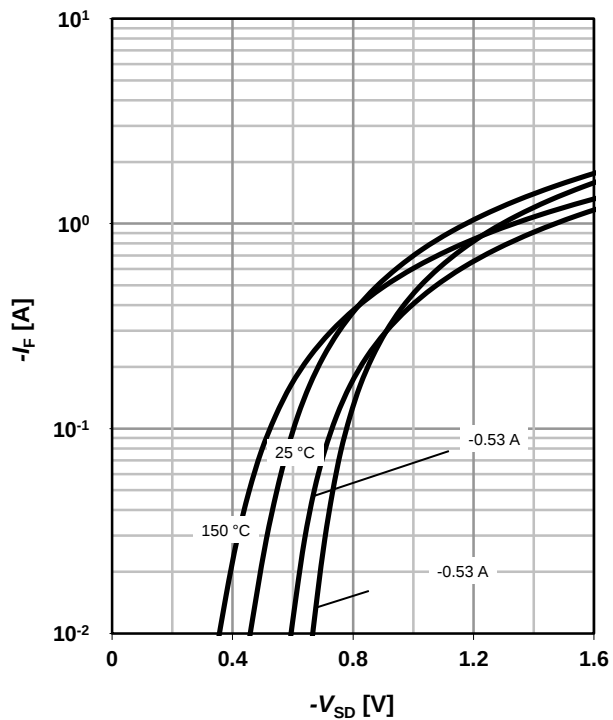
$R_{DS(on)} = f(T_j); I_D = 0.95 \text{ A}; V_{GS} = 4.5 \text{ V}$



**21 Forward characteristics of reverse diode (P)**

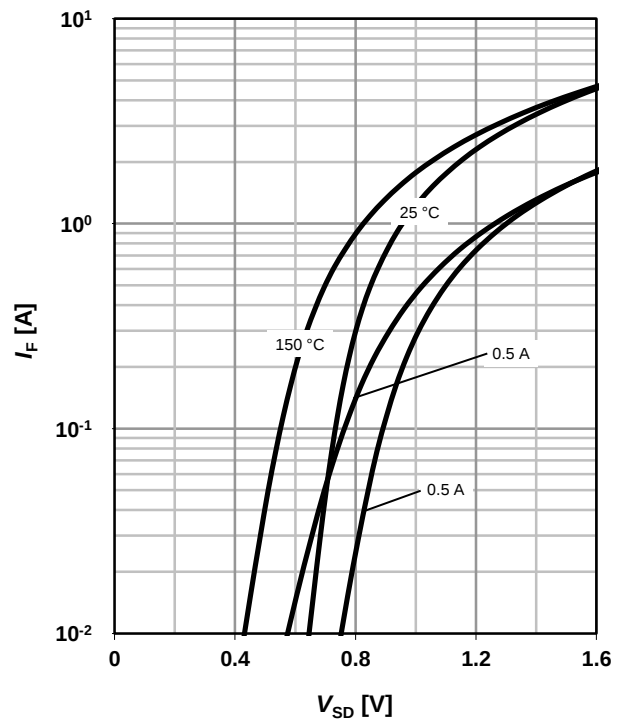
$$I_F = f(V_{SD})$$

parameter:  $T_j$


**22 Forward characteristics of reverse diode (N)**

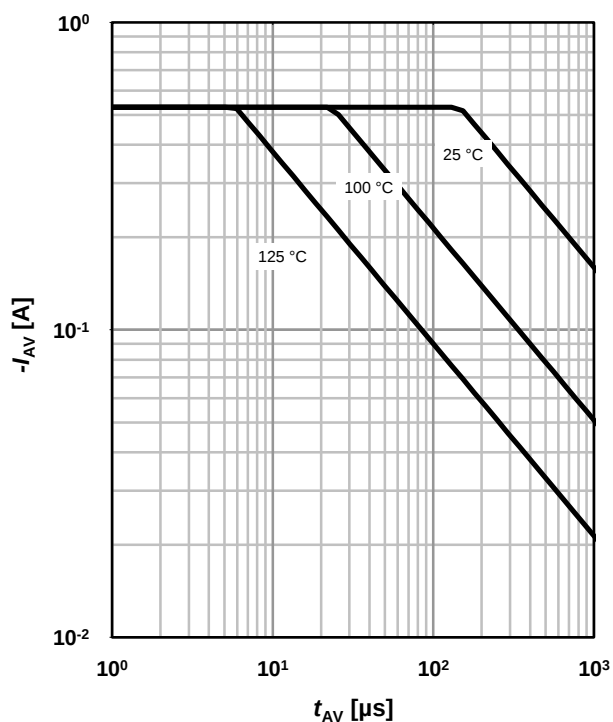
$$I_F = f(V_{SD})$$

parameter:  $T_j$


**23 Avalanche characteristics (P)**

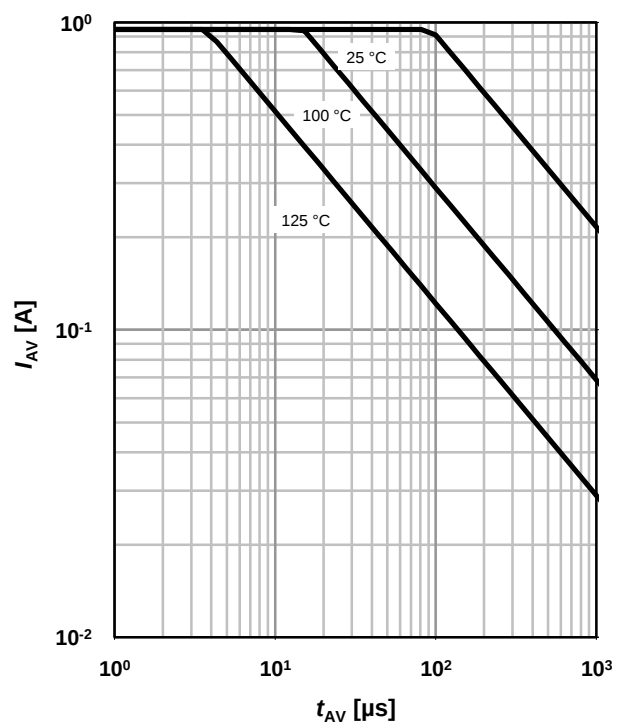
$$I_{AS} = f(t_{AV}); R_{GS} = 25 \Omega$$

parameter:  $T_{j(start)}$


**24 Avalanche characteristics (N)**

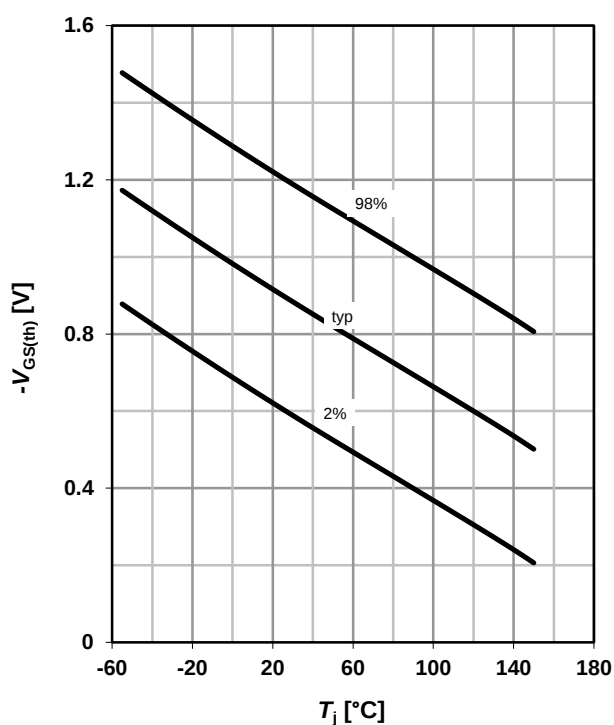
$$I_{AS} = f(t_{AV}); R_{GS} = 25 \Omega$$

parameter:  $T_{j(start)}$



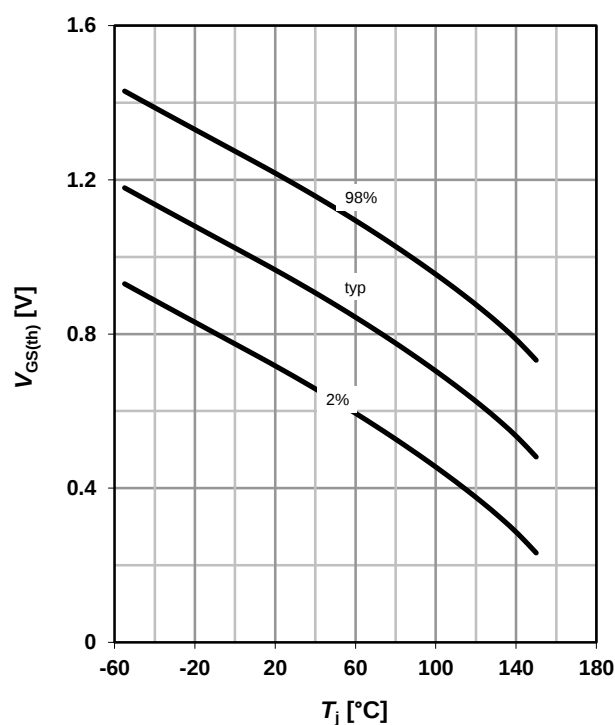
### 17 Typ. gate threshold voltage (P)

$V_{GS(th)} = f(T_j)$ ;  $V_{GS} = V_{DS}$ ;  $I_D = -1.5 \mu A$



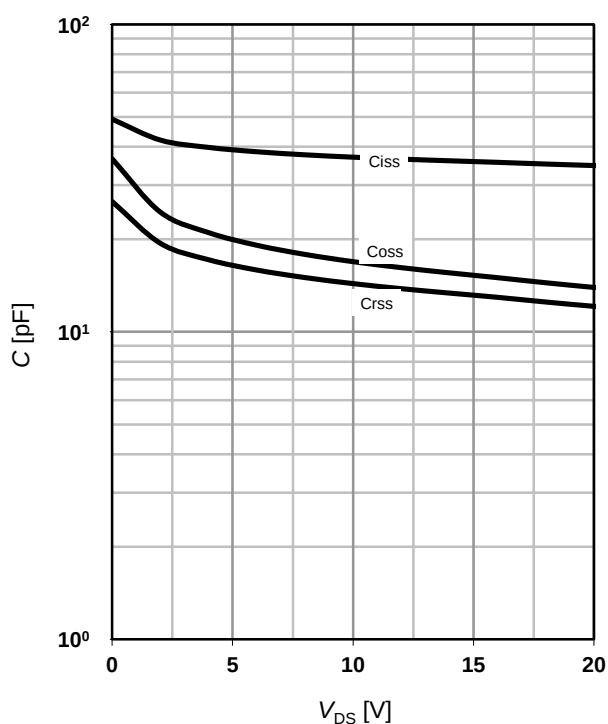
### 18 Typ. gate threshold voltage (N)

$V_{GS(th)} = f(T_j)$ ;  $V_{GS} = V_{DS}$ ;  $I_D = 1.6 \mu A$



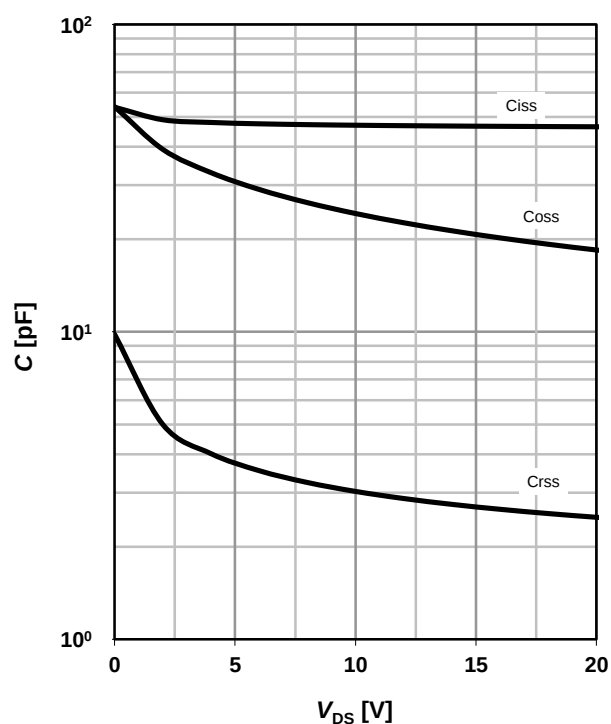
### 19 Typ. capacitances (P)

$C = f(V_{DS})$ ;  $V_{GS} = 0 V$ ;  $f = 1 MHz$



### 20 Typ. capacitances (N)

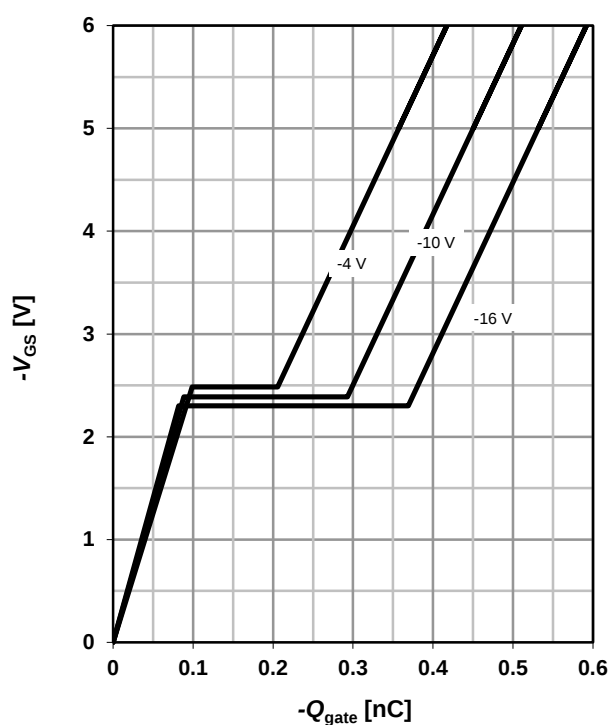
$C = f(V_{DS})$ ;  $V_{GS} = 0 V$ ;  $f = 1 MHz$



## 25 Typ. gate charge (P)

$V_{GS}=f(Q_{gate}); I_D=-0.53$  A pulsed

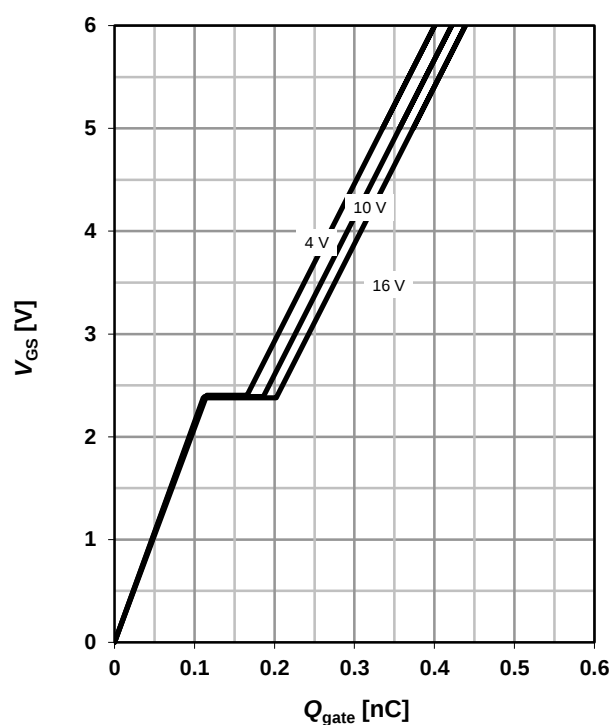
parameter:  $V_{DD}$



## 26 Typ. gate charge (N)

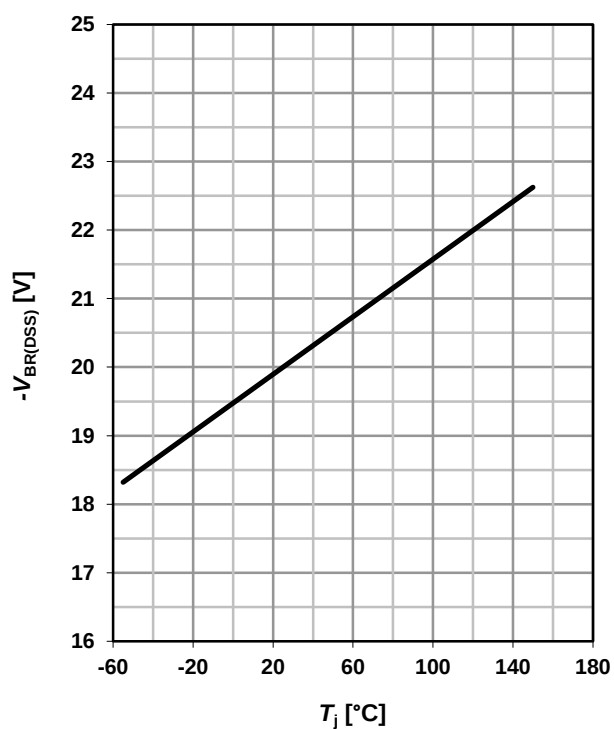
$V_{GS}=f(Q_{gate}); I_D=0.95$  A pulsed

parameter:  $V_{DD}$



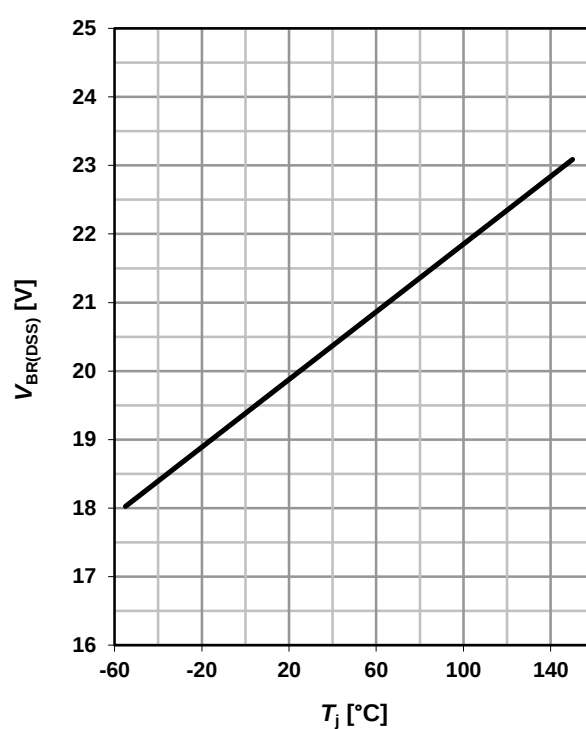
## 27 Drain-source breakdown voltage (P)

$V_{BR(DSS)}=f(T_j); I_D=-250$   $\mu$ A



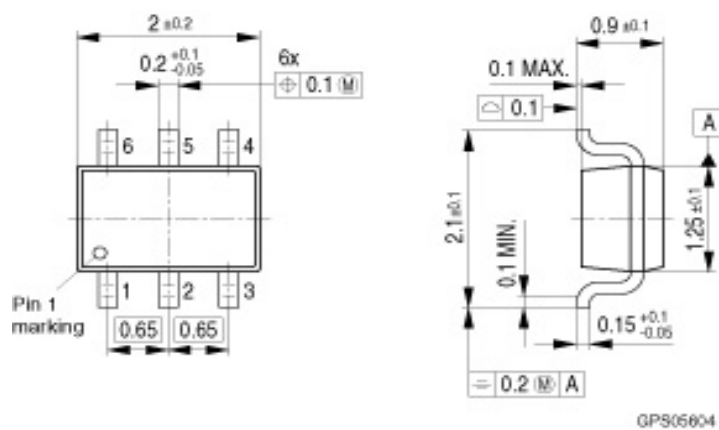
## 28 Drain-source breakdown voltage (N)

$V_{BR(DSS)}=f(T_j); I_D=250$   $\mu$ A

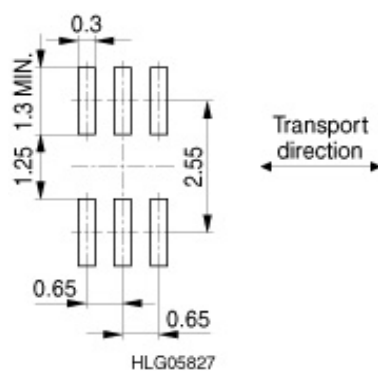


## SOT-363

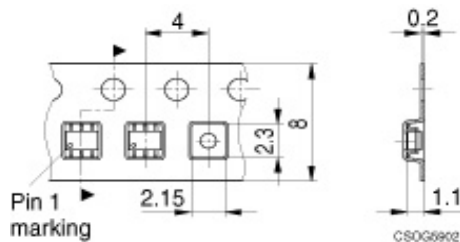
### Package Outline:



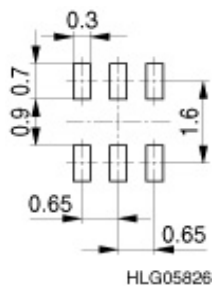
### Footprint:



### Packing:



### Reflow soldering:



Dimensions in mm

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#### **Warnings**

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А